

REMARKS

Claims 1 and 2 were pending in this Application. Claims 3 through 9 were canceled by way of an Examiner's Amendment dated December 2, 2005. New claim 10 has been added. Accordingly, claims 1, 2 and 10 are active.

Applicants respectfully request consideration of the Information Disclosure Statement (IDS) filed concurrently herewith. Moreover, Applicants respectfully request that an appropriately acknowledged and initialed PTO-1449 form be furnished to Applicant with the next Office communication.

Applicant submits that claims 1, 2 and 10 are patentably distinct from the references cited in the accompanying IDS. Claim 1 describes an interconnect line embedded in the insulating layer. None of the references cited in the IDS disclose or suggest an interconnect line embedded in the insulating layer, as claimed. Rather, the interconnect line (electrode pattern) of each of the references is formed on the surface of a substrate and not embedded in the insulating film.

It is believed that all pending claims are now in condition for allowance. Applicants therefore respectfully request an early and favorable reconsideration and allowance of this application. If there are any outstanding issues which might be resolved by an interview or an Examiner's amendment, the Examiner is invited to call Applicants' representative at the telephone number shown below.

Application No.: 10/784,268

To the extent necessary, a petition for an extension of time under 37 C.F.R. 1.136 is hereby made. Please charge any shortage in fees due in connection with the filing of this paper, including extension of time fees, to Deposit Account 500417 and please credit any excess fees to such deposit account.

Respectfully submitted,

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